Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!

Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832
Email & Skype: info@chipsmall.com Web: www.chipsmall.com
Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China

FAIRCHILD SEMICONDUCTOR™

June 1996
Revised November 2000

74ACT1284
IEEE 1284 Transceiver

General Description

The 74ACT1284 contains four non-inverting bidirectional buffers and three non-inverting buffers with open Drain outputs and high drive capability on the B Ports. It is intended to provide a standard signaling method for a bi-direction parallel peripheral in an Extended Capabilities Port mode (ECP).

The HD (active HIGH) input pin enables the B Ports to switch from open Drain to a high drive totem pole output, capable of sourcing 14 mA on all seven buffers. The DIR input determines the direction of data flow on the bidirectional buffers. DIR (active HIGH) enables data flow from A Ports to B Ports. DIR (active LOW) enables data flow from B Ports to A Ports.

Features

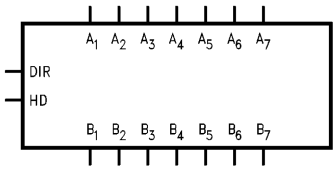
- TTL-compatible inputs
- A Ports have standard 4 mA totem pole outputs
- Typical input hysteresis of 0.5V
- B Port high drive source/sink capability of 14 mA
- Bidirectional non-inverting buffers
- Supports IEEE P1284 Level 1 and Level 2 signaling standards for bidirectional parallel communications between personal computers and printing peripherals
- B Port outputs in High Impedance mode during power down
- Guaranteed 4000V minimum ESD protection

Ordering Code:

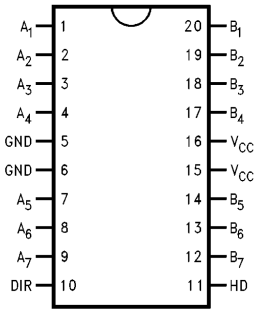
Order Number	Package Number	Package Description
74ACT1284SC	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
74ACT1284MSA	MSA20	20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide
74ACT1284MTC	MTC20	20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide

Device also available in Tape and Reel. Specify by appending suffix letter "X" to the ordering code.

Logic Symbol



Connection Diagram



Pin Descriptions

Pin Names	Description
HD	High Drive Enable input (Active HIGH)
DIR	Direction Control Input
A_1 - A_4	Side A Inputs or Outputs
B_1 - B_4	Side B Inputs or Outputs
A_5 - A_7	Side A Inputs
B_5 - B_7	Side B Outputs

FACT™ is a trademark of Fairchild Semiconductor Corporation.

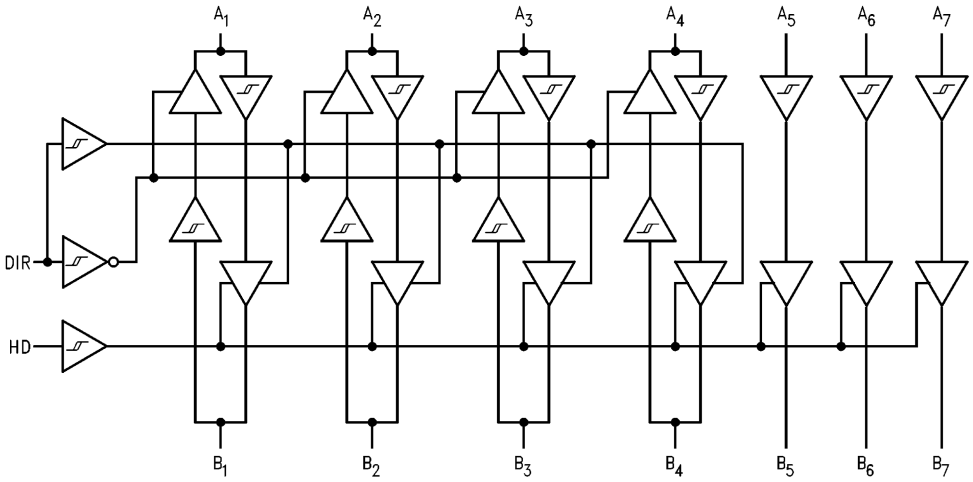
Truth Table

Inputs		Outputs
DIR	HD	
L	L	B_1- B_4 Data to A_1 - A_4, and A_5 - A_7 Data to B_5 - B_7 (Note 1)
L	H	B_1- B_4 Data to A_1 - A_4, and A_5 - A_7 Data to B_5 - B_7
H	L	A_1 - A_7 Data to B_1 - B_7 (Note 2)
H	H	A_1 - A_7 Data to B_1 - B_7

Note 1: B_5 - B_7 Open Drain Outputs

Note 2: B_1 - B_7 Open Drain Outputs

Logic Diagram



Absolute Maximum Ratings(Note 3)

(Note 4)

Supply Voltage (V_{CC})	−0.5V to +7.0V
DC Input Diode Current (I_{IK})	
$V_I = -0.5V$	−20 mA
$V_I = V_{CC} + 0.5V$	+20 mA
DC Input Voltage (V_I) A Side	−0.5V to V_{CC} + 0.5V
DC Input Voltage (V_I) B Side	−2V to +7V
DC Output Diode Current (I_{OK})	
$V_O = -0.5V$	−20 mA
$V_O = V_{CC} + 0.5V$	+20 mA
DC Output Voltage (V_O) A Side	−0.5V to V_{CC} + 0.5V
DC Output Voltage (V_O) B Side	−2V to +7V
DC Output Source	
or Sink Current (I_O)	± 50 mA
DC V_{CC} or Ground Current	
per Output Pin (I_{CC} or I_{GND})	± 50 mA
Storage Temperature (T_{STG})	−65°C to +150°C

Recommended Operating Conditions

Supply Voltage (V_{CC})	4.7V to 5.5V
Input Voltage (V_I)	0V to V_{CC}
Output Voltage (V_O)	0V to V_{CC}
Operating Temperature (T_A)	−40°C to +85°C

Note 3: Absolute maximum ratings are those values beyond which damage to the device may occur. The databook specifications should be met, without exception, to ensure that the system design is reliable over its power supply, temperature, and output/input loading variables. Fairchild does not recommend operation of FACT™ circuits outside databook specifications.

Note 4: Either voltage limit or current limit is sufficient to protect inputs.

DC Electrical Characteristics

Symbol	Parameter	V_{CC} (V)	Guaranteed Limits			Units	Conditions
			$T_A = +25°C$	$T_A = 0°C$ to $+70°C$	$T_A = -40°C$ to $+85°C$		
V_{IH}	Minimum HIGH Level Input Voltage	4.7	2.0	2.0	2.0	V	Recognized High Signal
		5.5	2.0	2.0	2.0		
V_{IL}	Maximum LOW Level Input Voltage	4.7	0.8	0.8	0.8	V	Recognized Low Signal
		5.5	0.8	0.8	0.8		
V_{OH}	Minimum HIGH Level Output Voltage	4.7	4.5	4.5	4.5	V	$I_{OUT} = -50$ µA (An), $V_{IN} = V_{IL}$ or V_{IH} (Note 5)
			3.7	3.7	3.7		$I_{OH} = -4$ mA (A_n)
			2.4	2.4	2.4		$I_{OH} = -14$ mA (B_n)
V_{OL}	Maximum LOW Level Output Voltage	4.7	0.2	0.2	0.2	V	$I_{OUT} = 50$ µA (An), $V_{IN} = V_{IL}$ or V_{IH} (Note 5)
			0.4	0.4	0.4		$I_{OH} = 4$ mA (A_n)
							$I_{OH} = 14$ mA (B_n)
I_{IN}	Maximum Input Leakage Current	5.5		±0.1	±1.0	µA	$V_I = V_{CC}$, GND (DIR, A5, A6, A7, HD)
I_{CCT}	Maximum I_{CC}/Input	5.5		1.5	1.5	mA	$V_I = V_{CC} - 2.1V$
I_{CC}	Maximum Quiescent Supply Current	5.5	400	400	500	µA	$V_{IN} = V_{CC}$ or GND
I_{OZ}	Maximum Output Leakage Current	5.5	±20	±20	±20	µA	$V_O = V_{CC}$, GND
I_{OFF}	Maximum B-Side Power Down Leakage Current	0.0	100	100	100	µA	$V_{OUT} = 5.25V$
Δ_{VT}	Input Hysteresis	5.0	0.4	0.4	0.35	V	$V_{T+} - V_{T-}$
R_D	Maximum Output Impedance	5.0	22	22	24	Ω	B_n (Note 6)
	Minimum Output Impedance	5.0	8	8	6	Ω	B_n (Note 6)

Note 5: All outputs loaded; thresholds on input associated with output under test.

Note 6: This parameter is guaranteed but not tested, characterized only: RD is the measure of the B-Side output impedance with the output in the HIGH state.

AC Electrical Characteristics

Symbol	Parameter	$T_A = +25°C$ $V_{CC} = 4.7V - 5.5V$		$T_A = 0°C$ to $+70°C$ $V_{CC} = 4.7V - 5.5V$		$T_A = -40°C$ to $+85°C$ $V_{CC} = 4.7V - 5.5V$		Units	Figure Number
		Min	Max	Min	Max	Min	Max		
t_{PHL}	A_1- A_7 to B_1 - B_7	2.0	20.0	2.0	20.0	2.0	24.0	ns	Figure 1
t_{PLH}	A_1- A_7 to B_1 - B_7	2.0	20.0	2.0	20.0	2.0	24.0	ns	Figure 2
t_{PHL}	B_1 - B_4 to A_1 - A_4	2.0	20.0	2.0	20.0	2.0	24.0	ns	Figure 3
t_{PLH}	B_1 - B_4 to A_1 - A_4	2.0	20.0	2.0	20.0	2.0	24.0	ns	Figure 3
$t_{pEnable}$	Output Enable Time HD to B_1 - B_7	2.0	20.0	2.0	20.0	2.0	24.0	ns	Figure 2
$t_{pDisable}$	Output Disable Time HD to B_1 - B_7	2.0	20.0	2.0	20.0	2.0	24.0	ns	Figure 2
t_{SKEW} t_{PLH} t_{PHL}	Output Slew Rate B_1 - B_7	0.05	0.40	0.05	0.40	0.05	0.40	V/ns	Figures 1, 2
t_r, t_f	t_{RISE} and t_{FALL} B_1 - B_7 (Note 7)		120		120		120	ns	Figure 4 (Note 8)

Note 7: Open Drain

Note 8: This parameter is guaranteed but not tested, characterized only.

Note: Pulse Generator for all pulses; Rate ≤ 1.0 MHz; $A_O \leq 50\Omega$; $t_f \leq 2.5$ ns, $t_r \leq 2.5$ ns.

Capacitance

Symbol	Parameter	Typ	Units	Conditions
C_{IN}	Input Capacitance	4.0	pF	V_{CC} = OPEN (HD, DIR A_5 - A_7)
$C_{I/O}$	I/O Pin Capacitance	12.0	pF	V_{CC} = 5.0V

AC Loading and Waveforms

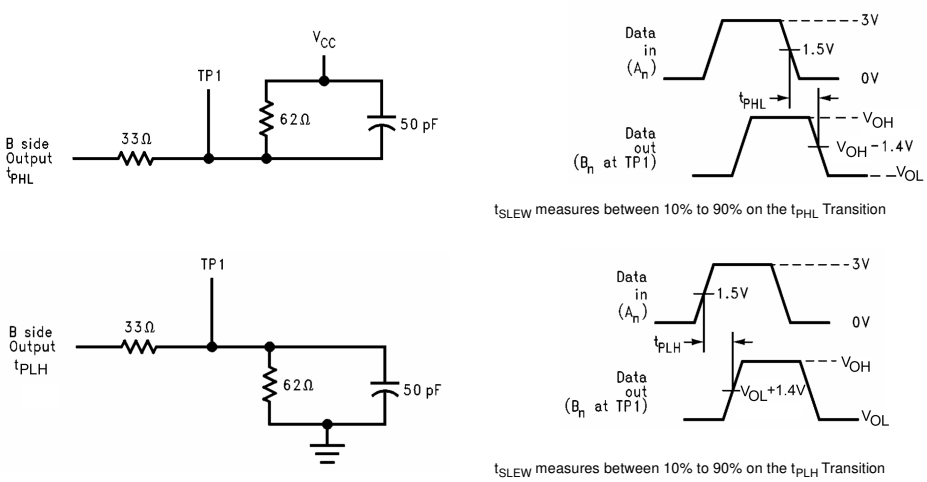


FIGURE 1. Port A to B Propagation Delay Waveforms

FIGURE 2. B Output Test Load and Waveforms

FIGURE 3. B to A Direction Test Load and Waveforms for Outputs A_1 - A_4

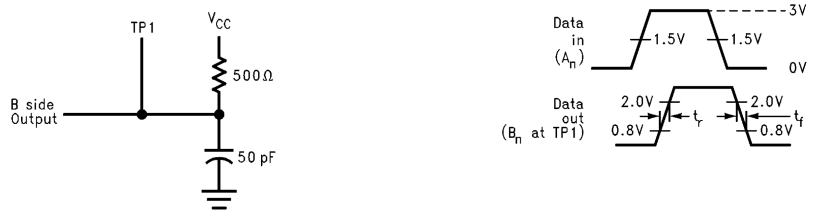
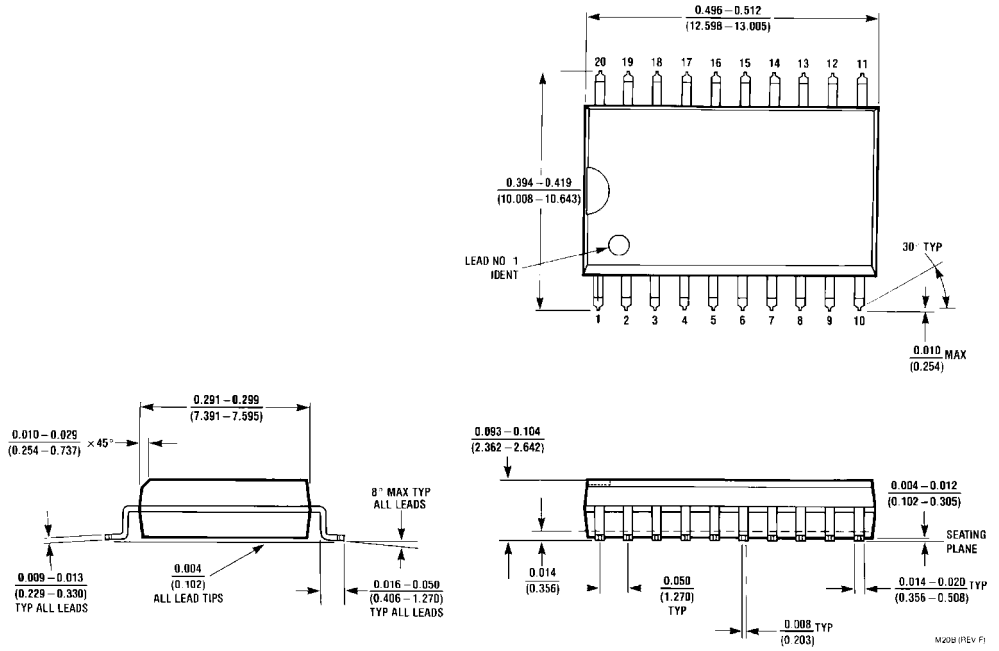
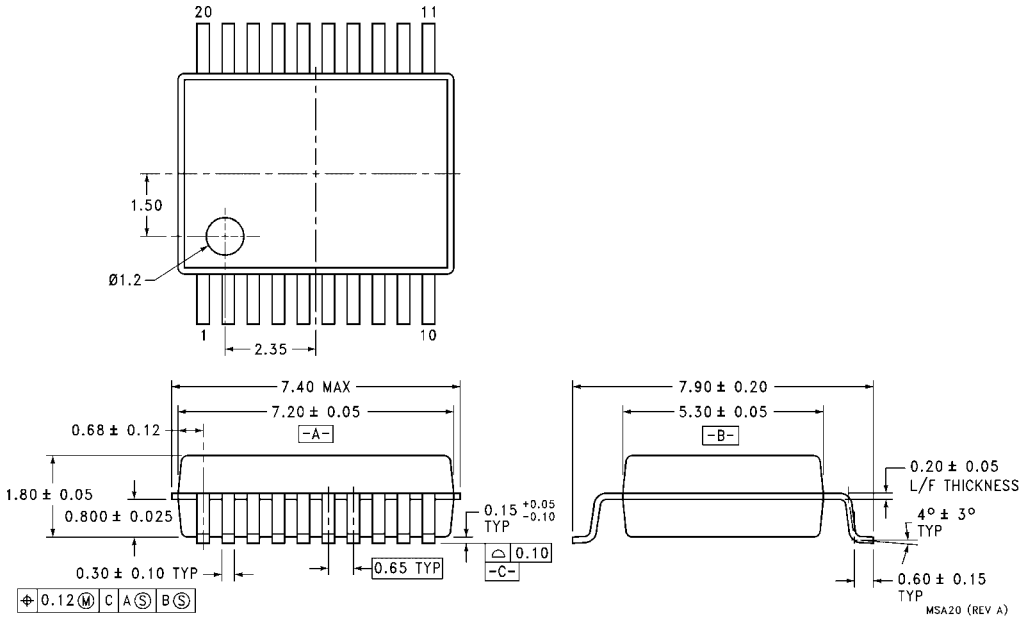


FIGURE 4. A to B Direction Test Load and Waveforms for Open Drain B_1 - B_7

Physical Dimensions inches (millimeters) unless otherwise noted

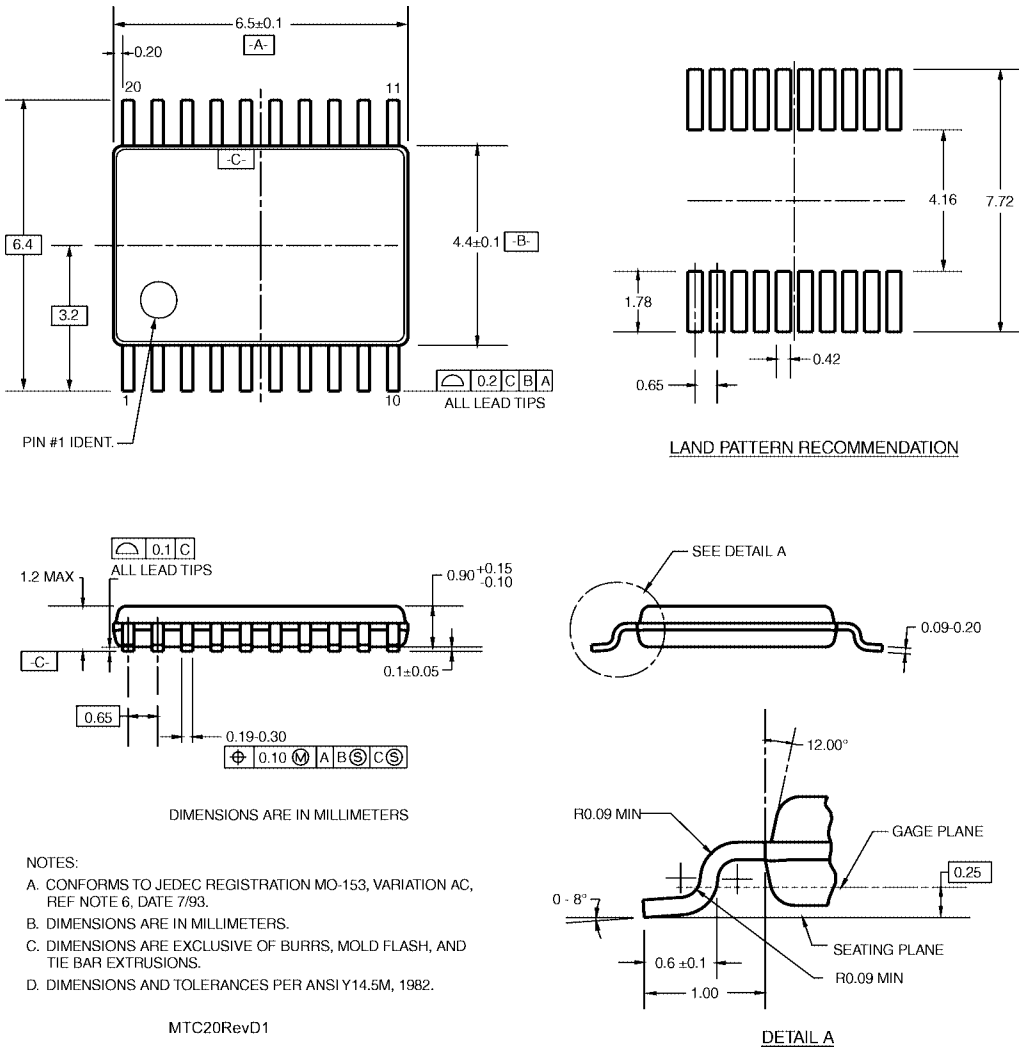


20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300" Wide
Package Number M20B



20-Lead Shrink Small Outline Package (SSOP), EIAJ TYPE II, 5.3mm Wide
Package Number MSA20

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)



NOTES:

A. CONFORMS TO JEDEC REGISTRATION MO-153, VARIATION AC, REF NOTE 6, DATE 7/93.

B. DIMENSIONS ARE IN MILLIMETERS.

C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

D. DIMENSIONS AND TOLERANCES PER ANSI Y14.5M, 1982.

MTC20RevD1

20-Lead Thin Shrink Small Outline Package (TSSOP), JEDEC MO-153, 4.4mm Wide
Package Number MTC20

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF THE PRESIDENT OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury to the user.
2. A critical component in any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

www.fairchildsemi.com